

# **BERGSTAK® 0.8MM MEZZANINE CONNECTORS**

Extra-ordinary Product Range; Benchmark Performance; Dual-source Champion

#### **DESCRIPTION**

Versatile, high density parallel-board-to-board connector system offers twelve PCB stack heights in nine sizes up to two hundred positions.

Stack height flexibility supports evolving designs and emerging mechanical requirements with a common mating interface.

Special housing and blade-on-beam terminal features provide easy PCB assembly, worry-free mating and long-term reliability.



# **FEATURES & BENEFITS**

- 0.8mm double-row contact pitch conserves printed circuit board space
- Vast range of sizes and stack heights support diverse electronic packaging schemes
  - 40 to 200 position sizes in 20 position increments
  - 5mm to 16mm stack heights in 1mm increments
- Choice of gold-based and palladium-based platings provide protection in different environments and applications
- Tapered PCB locator pegs increase the ease and accuracy of hand assembly
- Blade-on-beam contacts allow peeling for safer, easier un-mating
- Tape and Reel packaging supports high speed automated assembly
- Optimize from Gen.2 to Gen.3 high speed performance on some stack heights
- Fully inter-matable with similar competitive connectors

# **PLUS**

- Optimized "blade-on-beam" contact mating maximizes connection integrity
  - Early receptacle contact point increases mating wipe and allows early engagement/late disengagement
  - Precision-tapered contacts control mating stress while providing reliable, high normal force
  - Coined contact tips assure smooth, safe wiping action during connector mating
  - Connector polarization, generous lead-in angles and precise contact positioning ensure precise mating alignment and reliability

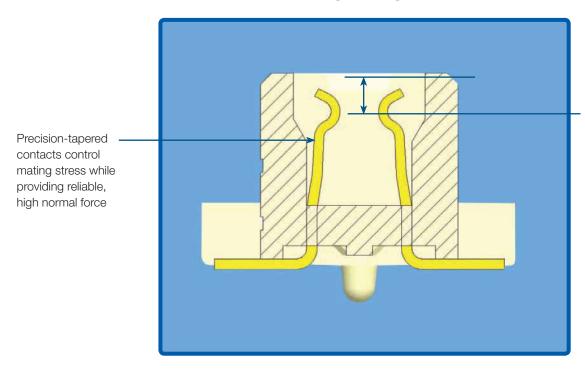
# TARGET MARKETS / APPLICATIONS

- Routers
- Servers
- Telecom/Datacom equipment
- Office equipment
- IP phones
- Test and Measurement
- ► Point-of-Sale terminals
- Portable industrial terminals



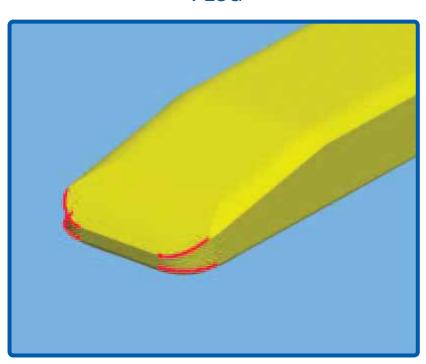


# **RECEPTACLE**



Early-contact point allows early engagement / late disengagement and increases mating wipe

# **PLUG**

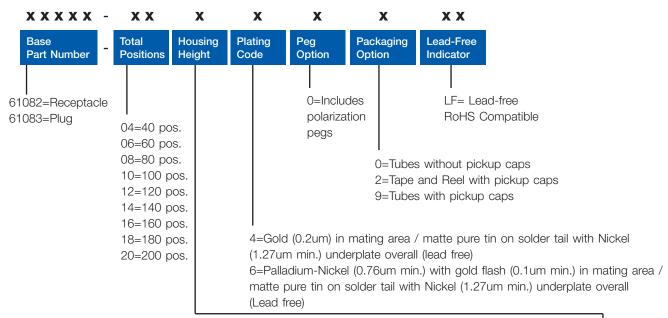


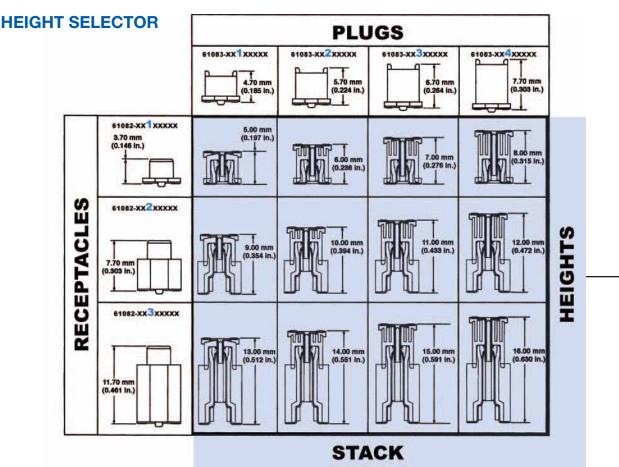
Coined contact tips assure smooth, safe wiping action during connector mating

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## **PART NUMBER SELECTOR**





For special additional options and updates, consult drawings at www.fci.com/bergstak



#### **TECHNICAL INFORMATION**

#### **MATERIALS**

- Housing
  - Glass filled LCP (UL94 V-0)
- Contact base metal
  - Receptacles: Copper Alloy, High Spring
  - Plugs: Brass
- Contact area finish
  - Gold or Gold flash over palladium-nickel (GXT) over nickel
- Solder area finish
  - Matte pure tin over nickel

#### MECHANICAL PERFORMANCE

- Durability: 100 cycles
- Mating force: 0.9N (90 gramf) maximum/contact
  Un-mating force: 0.1N (10 gramf) minimum/contact

## **ENVIRONMENTAL**

- Temperature range: -40°C to +85°C
- ► High temperature life: 105°C +/- 5°C for 1000 hours
  ► Humidity: 90-95% relative humidity for 96 hours
- Mixed Flowing Gas Class 2a (30 GXT)

#### **SPECIFICATION**

- GS-12-547 BergStak 0.8mm Product Specification
- GS-29-010 Test report, Competitive inter-mating

#### **ELECTRICAL PERFORMANCES**

- Insulation resistance:
  - Initial: 1000 MΩ minimum
  - After test: 100 MΩ minimum
- Current rating:
  - 0.8 amp/contact
- Contact resistance:
  - Initial: 30 mΩ maximum
  - After test: 50 mΩ maximum
- Voltage rating:
  - 100 V AC
- Signal Integrity

(Differential pairs, connector and SMT pads only)

- Impedance Range: 81 to 108 ohms @ 50 ps edge (10-90%)
- Return Loss: < 10 dB up to 5 GHz
- Insertion Loss: < 1.5 dB up to 5 GHz
- NEXT: ≤ 4.0% for a 50 ps edge (10-90%)
- FEXT: ≤ 2.4% for a 50 ps edge (10-90%)
- S Parameter models available at www.fci.com/bergstak

## APPROVALS AND CERTIFICATIONS

- UL certificate, file no. E66906
- CSA, file no. LR46923

## **PACKAGING**

- Tape and reel
- Tubes

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Choose precisely what you need from FCI's MezzSelect™ product portfolio.

In-line and array-configured connectors satisfy a wide range of low-to-high pin count and low-to-high speed applications in many electronics segments.

The MezzSelect™ Connector Family is supported by simple, powerful web-based design tools and other resources to help customers expedite connector design work and improve time-to-market.

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Please note that the information in this datasheet is subject to change without notice. Visit www.fciconnect.com/bergstak for additional technical information.

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